SP	EC	IFI	CA	TIC)NS

CUSTOMER . PTC

SAMPLE CODE . SH320240T023-IHC

MASS PRODUCTION CODE . PH320240T023-IHC

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 006

DRAWING NO. (Ver.) . JLMD-PH320240T023-IHC_005

PACKAGING NO. (Ver.) . JPKG-PH320240T023-IHC_001

Customer Approved

Date:

2017.03.15

Approved	Approved Checked			
 	張久慧	劉進		

☐ Preliminary specification for design input

Specification for sample approval

POWERTIP TECH. CORP.

Headquarters: No.8, 6th Road, Taichung Industrial Park,

Taichung, Taiwan

TEL: 886-4-2355-8168

E-mail: sales@powertip.com.tw

台中市 407 工業區六路 8號

FAX: 886-4-2355-8166

Http://www.powertip.com.tw



History of Version

Date	Ver.	Edi.	Description	Page	Design by
06/23/2016	01	001	New Drawing	-	劉進
07/25/2016	01	002	Second Drawing: Update LCM Brightness	6	劉進
09/09/2016	01	003	Modify Specs.(Drawing)	-	劉進
01/05/2017	01	004	New Sample	-	劉進
02/12/2017	01	005	Modify Backlight Circuit diagram Modify Capacitive Touch Panel Pin NO.	9 Appendix	劉進
03/14/2017	01	006	Update Drawing	Appendix	劉進
		X			

Total: 32 Pages



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Appendix: LCM Drawing

Packaging

Note: For detailed information please refer to IC data sheet:

Primacy(TFT LCD): Himax: HX8238-D



1. SPECIFICATIONS

1.1 **Features**

Item	Standard Value				
Display Resolution	320 * (RGB) * 240 Dots				
LCD Type	a-Si TFT , Normally white , Transmissive type				
Touch panel	Projective capacitive touch panel				
	True Multi-touch with up to 5 Points of Absolution				
Screen size(inch)	3.5 inch				
Viewing Direction	6 O'clock				
Color configuration	R.G.B. Vertical Stripe				
Backlight Type	LED B/L				
Weight					
Interface	24 Bits RGB Interface				
Other					
(controller / driver IC)	Himax: HX8238-D				
(controller / driver ic)					
	THIS PRODUCT CONFORMS THE ROHS OF PTC				
ROHS	Detail information please refer website:				
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/				

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension(T/P)	84.02(W) x 75.36 (L) x 4.6 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	70.08 (W) * 52.56 (L)	mm

Touch panel

Item	Standard Value	Unit
Viewing Area	71.68 (W) * 54.16 (L)	mm

Note: For detailed information please refer to LCM drawing.



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Supply Voltage	VDD	GND=0	-0.3	+3.96	V	
Power Supply Voltage	VCC	GND=0	-0.3	+23.0	V	
Operating Temperature	TOP	-	-20	+70	°C	-
Storage Temperature	T _{ST}	-	-30	+80	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

1.4 DC Electrical Characteristics

Module $Ta = 25^{\circ}C$

Item	Symbol	mbol Condition		Тур.	Max.	Unit
Power Supply for TFT Panel	VDD	/DD GND=0V		3.3	3.6	V
Power Supply for Backlight Unit	VCC	GND=0V	5	12	14	V
Input Valtage for TET Danel	ViH	GND=0V	0.7VDD	1	VDD	V
Input Voltage for TFT Panel	VIL	GND=0V	0	-	0.3VDD	V
Supply Current for TFT Panel	IDD	IDD@VDD=3.3V	-	11	17	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=5V		100	150	mA
Supply Current for Backlight Offit	100	ICC@VCC=12V	1	50	75	mA
Input Voltage for PWM Signal	VPH	GND=0V	1.2	ı	-	V
input voltage for PVVIVI Signal	VPL	GND=0V	-	-	0.4	V
Dimming Clock Rate	fP	GND=0V	5	-	100	KHz



1.5 Optical Characteristics

VDD=3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time		Tr + Tf	-	-	40	60	ms	Note2
	Тор	θ+		-	60	-		
Viewing angle	Bottom	θ-	CR ≥ 10	-	60	-	Dog	Note4
Viewing angle	Left	θL	CR 2 10	-	60	·	Deg.	NOIE4
	Right	θR		-	60	-		
Contrast ration	0	CR	CR -		600	-	-	Note3
	White	Х		0.27	0.32	0.37		
	vvriite	Υ	VCC=12V	0.30	0.35	0.40		
	Red	Х		0.59	0.64	0.69		
Color of CIE		Y		0.29	0.34	0.39		
Coordinate (LCD & B/L & T/P)	Croon	Х	PWM="High" (Duty=100%)	0.29	0.34	0.39	-	
,	Green	Y	(Daty=10070)	0.56	0.61	0.66	1	Natad
	Dluc	Х		0.09	0.14	0.19		Note1
	Blue	Υ		0.03	0.08	0.13		
Average Brightness Pattern=white display (LCD & B/L & T/P)*1		IV	VCC=12V PWM="High"	680	850	-	cd/m ²	
Uniformity (LCD & B/L & T/	P)*2	∆В	(Duty=100%)	70	-	-	%	



Note 1:

*1 : △B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

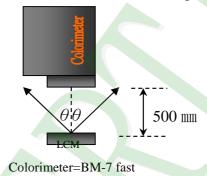
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





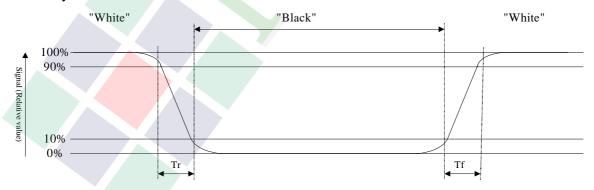
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

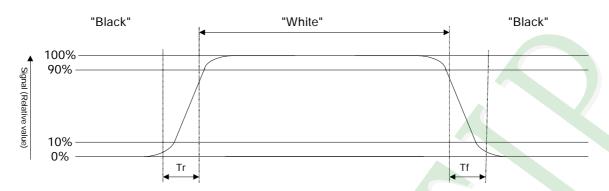
Refer to figure as below:

Normally White





Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

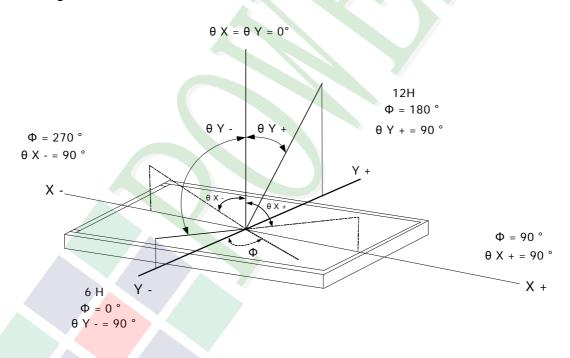
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

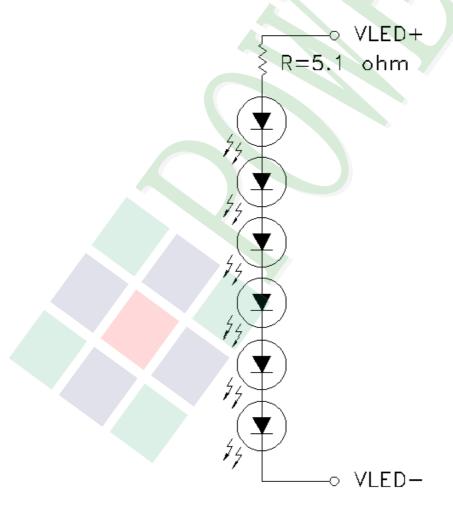
Item	Symbol	Min.	Max.	Unit	Remark
LED Forward Current	lF	30		mA	One LED
LED Reverse Voltage	V _R	Ę	5	V	One LED

Electrical / Optical Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
LED Voltage	VL	18	19	19.8	V	Note1
LED Current	IL	-	20	-	mA	/-
LED life time	-	50000		-	Hr	Note2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25℃ and I∟=20mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25 °C and I∟=20mA. The LED life time could be decreased if operating I∟ is larger than 20 mA.





1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	3.5"
Touch type	Projective capacitive touch panel
Input Method	Finger / 5 Points touch
Output Interface	I ² C
IC	ST1633

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	71.68 mm (W) x 54.16 mm (H)	mm
Number of sensing channel	12 (W) x 10 (H)	mm

Absolute Maximum Ratings

	.90				
Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	TPVDD		-0.3	+6.0	V
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	TPVDD	-	2.8	3.3	3.6	V
Input High Voltage	TPVIH	-	0.85 TPVDD	-	-	V
Input Low Voltage	TPVIL	-	-	-	0.15 TPVDD	V

Touch Panel IC Read/Write description & Register Mapping

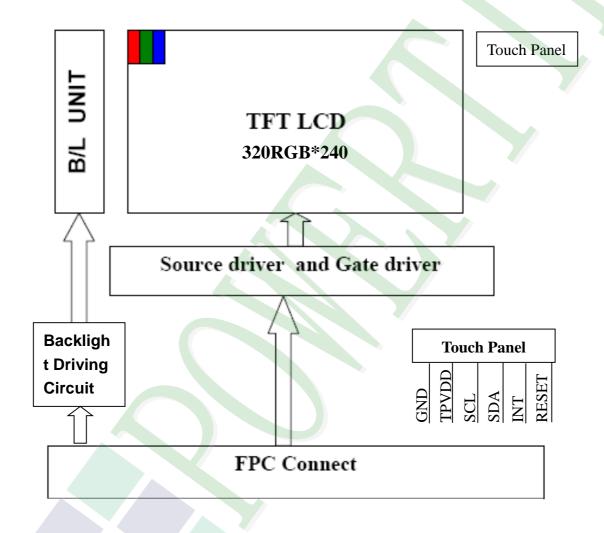
Reference: Sitronix Touch Driver Porting Reference Guide.



2. MODULE STRUCTURE

2.1 Counter Drawing

- 2.1.1 LCM Mechanical Diagram
 - * See Appendix
- 2.1.2 Block Diagram





2.2 Interface Pin Description

TFT LCM Interface

Pin No.	Symbol	Function
1	GND	Power ground.
2	VDD	Power for Digital Circuit.
3	VDD	Power for Digital Circuit.
4	VCC	Power For LED backlight.
5	VCC	Power For LED backlight.
6	PWM	Shutdown & Dimming control input for backlight. Do not allow this pin to float. "Hi" =100%, "Low" = 0%.
7	GND	Power ground.
8	R0	Red Data.
9	R1	Red Data.
10	R2	Red Data.
11	R3	Red Data.
12	GND	Power ground.
13	R4	Red Data.
14	R5	Red Data.
15	R6	Red Data.
16	R7	Red Data.
17	GND	Power ground.
18	G0	Green Data.
19	G1	Green Data.
20	G2	Green Data.
21	G3	Green Data.
22	GND	Power ground.
23	G4	Green Data.
24	G5	Green Data.
25	G6	Green Data.
26	G7	Green Data.
27	GND	Power ground.
28	В0	Blue Data.
29	B1	Blue Data.



Pin No.	Symbol	Function
30	B2	Blue Data.
31	В3	Blue Data.
32	GND	Power ground.
33	B4	Blue Data.
34	B5	Blue Data.
35	B6	Blue Data.
36	B7	Blue Data.
37	GND	Power ground.
38	HS	Line synchronization signal. Horizontal Sync Input.
39	VS	Frame synchronization signal. Vertical Sync Input.
40	GND	Power ground.
41	DE	Display enable pin from controller. Data Input Enable.
42	GND	Power ground.
43	DCLK	Sample clock. Data will be latched at the falling edge of DCLK.
44	GND	Power ground.
45	CS / ID1	Chip Select/ ID[4:1]These pins select LCM type.
46	SDIN / ID2	SPI Data/ ID[4:1]These pins select LCM type.
47	SCK / ID3	SPI Clock/ ID[4:1]These pins select LCM type.
48	DISPLAY	Display Enable (Hi Active) / ID[4:1]These pins select LCM type.
	CONTROL / ID4	
49	/RESET	Global Reset (Low Active).
50	GND	Power ground.

Capacitive Touch Panel (CTP) Interface

Pin No.	Symbol	Function
1	GND	Ground.
2	TPVDD	Power.
3	SCL	I ² C Clock.
4	SDA	I ² C Data.
5	INT	The interrupt from the CTP to the Host.
6	RESET	RESET.



2.2.1 Refer Initial Code

HX8238-D register configuration is recommended to use the default value (HSP=0, VSP=0, CKP=0, DEP=0).

Note:

HSP: When HSP=0, HS(HSYNC) is negative polarity. When HSP=1, HS(HSYNC) is positive polarity.

VSP: When VSP=0, VS(VSYNC) is negative polarity. When VSP=1, VS(VSYNC) is positive polarity.

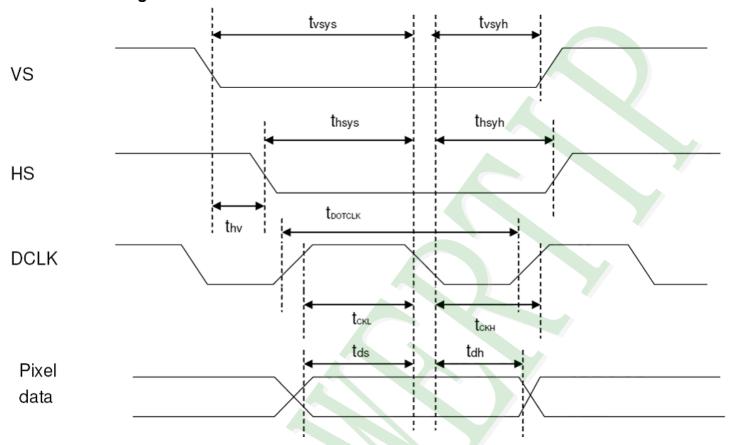
CKP: When CKP=0, data is latched in DCLK falling edge. When CKP=1, data is latched in DCLK rising edge.

DEP: When DEP=0, DE is negative polarity active. When DEP=1, DE is positive polarity active.





2.3 Timing Characteristics 2.3.1 Pixel timing for HX8238-D

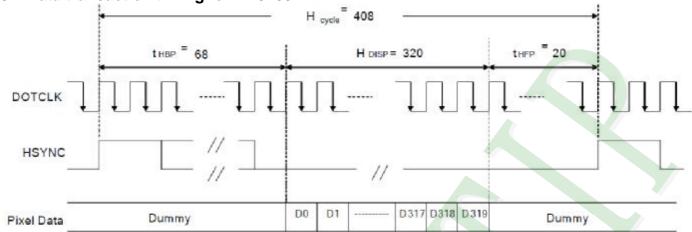


Characteristics	Symbol	Min	Тур	Max	Unit
DCLK Frequency	fDCLK		6.5	10	MHz
DCLK Period	tDCLK	100	154	ı	ns
Vertical Sync Setup Time	tvsys	20	1	1	ns
Vertical Sync Hold Time	tvsyh	20	-	1	ns
Horizontal Sync Setup Time	thsys	20	-	1	ns
Horizontal Sync Hold Time	thsyh	20		·	ns
Phase difference of Sync Signal Falling Edge	thv	1	1	240	tDCLK
DCLK Low Period	tCKL	50	-	-	ns
DCLK High Period	tCKH	50	-	1	ns
Data Setup Time	tds	12	•	1	ns
Data hold Time	tdh	12	•	-	ns
Reset pulse width	tRES	10	-	-	us

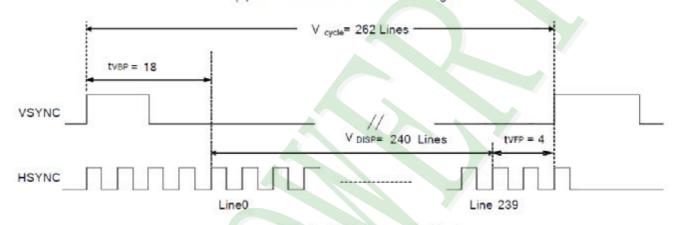
Note: External clock source must be provided to DOTCLK pin of HX8238-A. The driver will not operate if absent of the clocking signal. Pixel timing



2.3.2 Data transaction timing for HX8238-D



(a) Horizontal Data Transaction Timing



(b) Vertical Data Transaction Timing

Data transaction timing in parallel RGB (24 bit) interface (SYNC mode)

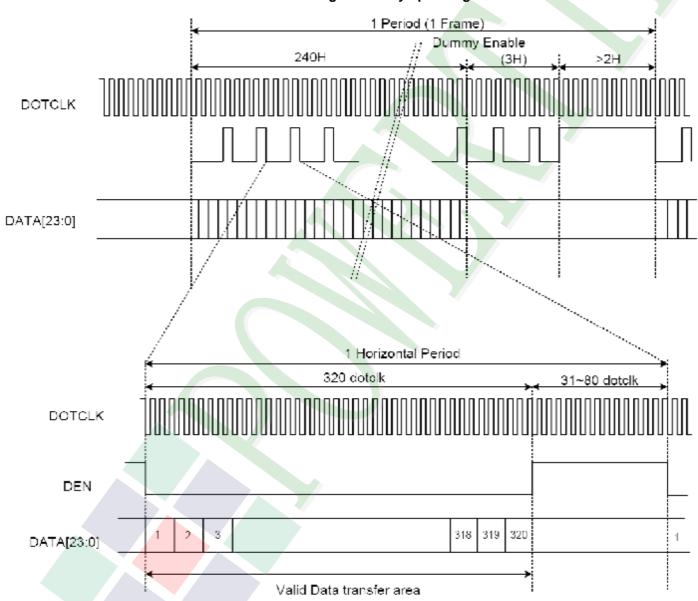
Characteristics	Symbol	Min	Тур	Max	Unit
DOTCLK Frequency	fDOTCLK	-	6.5	10	MHz
DOTCLK Period	tDOTCLK	100	154		ns
Horizontal Frequency (Line)	fH	-	14.9	22.35	KHz
Vertical Frequency (Refresh)	fV	-	60	90	Hz
Horizontal Back Porch	tHBP	1	68	-	tDOTCLK
Horizontal Front Porch	tHFP	-	20		tDOTCLK
Horizontal Data Start Point	tHBP		68	-	tDOTCLK
Horizontal Blanking Period	tHBP + tHFP	-	88	-	tDOTCLK
Horizontal Display Area	HDISP		320		tDOTCLK
Horizontal Cycle	Hcycle	-	408	450	tDOTCLK
Vertical Back Porch	tVBP	-	18	-	Lines
Vertical Front Porch	tVFP	ı	4	-	Lines
Vertical Data Start Point	tVBP	ı	18	-	Lines
Vertical Blanking Period	tVBP + tVFP	-	22	-	Lines
Vertical Display Area	VDISP	-	240	-	Lines
Vertical Cycle	Vcycle	-	262	350	Lines

Data transaction timing in normal operating mode



Characteristics	Symbol	Min.	Typ.	Max.	Unit
DOTCLK Frequency	fDOTCLK	-	6.5	10	MHz
DOTCLK Period	tDOTCLK	100	154	-	ns
Horizontal Blanking Period	tHBP + tHFP	52	88	180	tDOTCLK
Horizontal Display Area	HDISP	-	320	-	tDOTCLK
Horizontal Cycle	Hcycle	372	408	500	tDOTCLK
Vertical Blanking Period	tVBP + tVFP	2	[#]	47	Lines
Vertical Display Area	VDISP	E	240		Lines
Vertical Cycle	Vcycle	242	1 	287	Lines

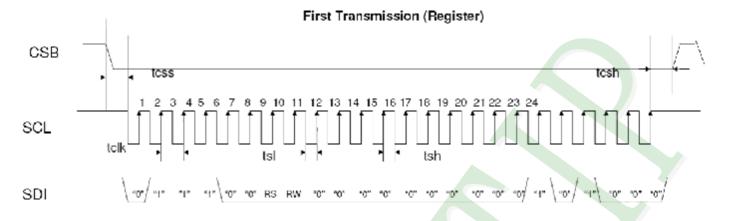
Data transaction timing in DE only operating mode

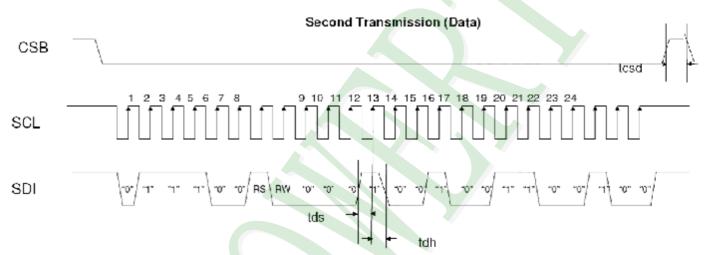


Signal timing in DE mode



2.3.3 SPI Timing Characteristics for HX8238-D





Note: The example transmit "0x1264h" to register R28h. SPID connected to VSS.

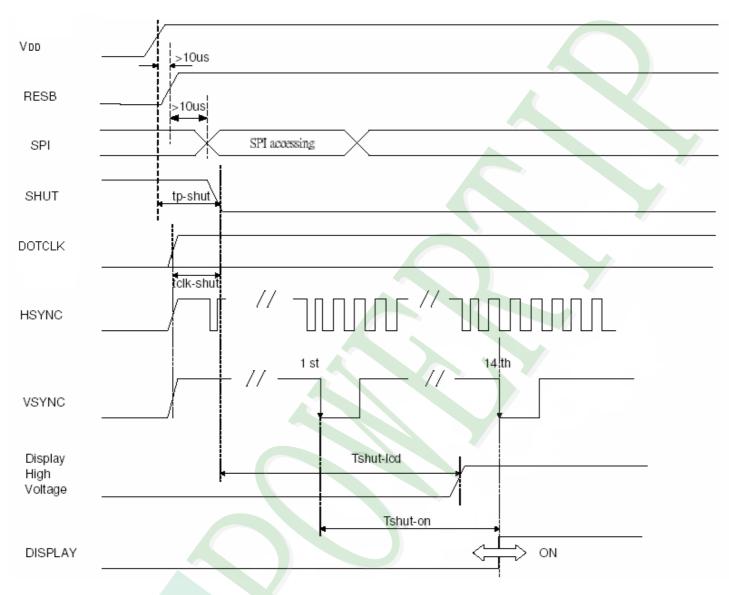
SPI interface timing diagram & transaction example

Characteristics	Symbol	Min	Тур	Max	Unit
Serial Clock Frequency	felk	-	-	20	MHz
Serial Clock Cycle Time	tclk	50	-	-	ns
Clock Low Width	tsl	25	-	-	ns
Clock High Width	tsh	25	-	-	ns
Chip Select Setup Time	tess	0	-	-	ns
Chip Select Hold Time	tesh	10	-	-	ns
Chip Select High Delay Time	tesd	20	-	-	ns
Data Setup Time	tds	5	-	-	ns
Data Hold Time	tdh	10	-	-	ns

SPI timing



2.4 Power Sequence 2.4.1 Power up sequence



Characteristics	Symbol	Min	Тур	Max	Units
VDD on to falling edge of SHUT	tp-shut	1	-	-	us
DOTCLK	tclk-shut	1	-	-	clk
Falling edge of SHUT to LCD power on	tshut-lcd	-	,	128	ms
Falling edge of SHUT to display start		-	-	14	frame
- 1 line: 408 clk - 1 frame: 262 line -DOTCLK = 6.5MHz	tshut-on	-	166	232.4	ms

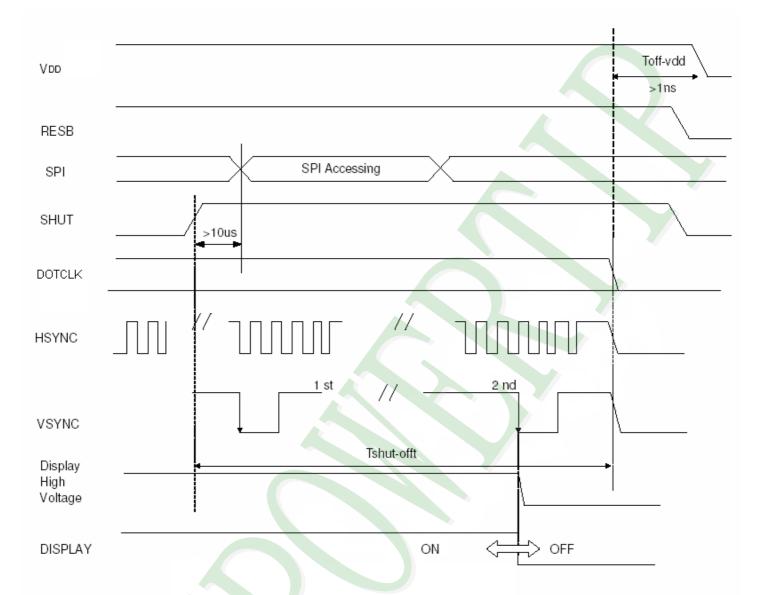
Note: It is necessary to input DOTCLK before the falling edge of SHUT.

Display starts at 10th falling edge of VSYNC after the falling edge of SHUT.

Interface PIN No. 48" Display control" have connected Inverters logic gates to the "SHUT" pin.



2.4.2 Power down sequence



Characteristics	Symbol	Min	Тур	Max	Uni
Rising edge of SHUT to display off		2	-	-	frame
- 1 line: 408 clk	tshut-off				
- 1 frame: 262 line	toriat on	33.4	-	-	ms
- DOTCLK = 6.5MHz					
Input-signal-off to VDD off	toff-vdd	1	-	-	us

Note: DOTCLK must be maintained at lease 2 frames after the rising edge of SHUT.

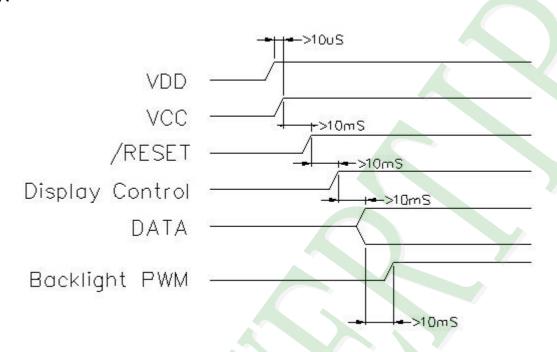
Display become off at the 2nd falling edge of VSYNC after the falling edge of SHUT.

If RESET signal is necessary for power down, provide it after the 2-frames-cycle of the SHUT period.

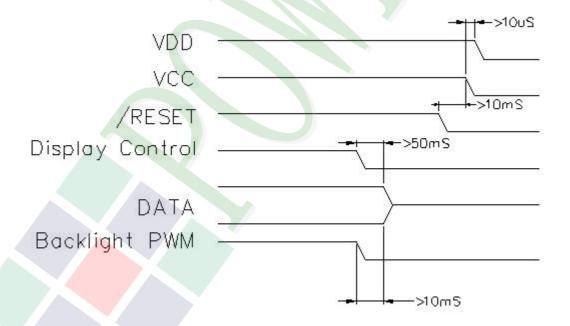


2.4.3 Power Timing Characteristics of Backlight

POWER ON



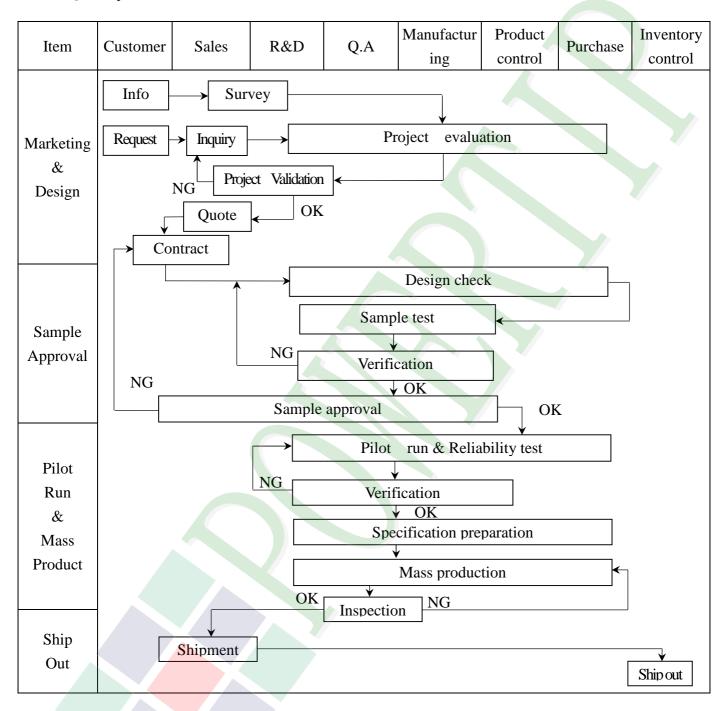
POWER OFF



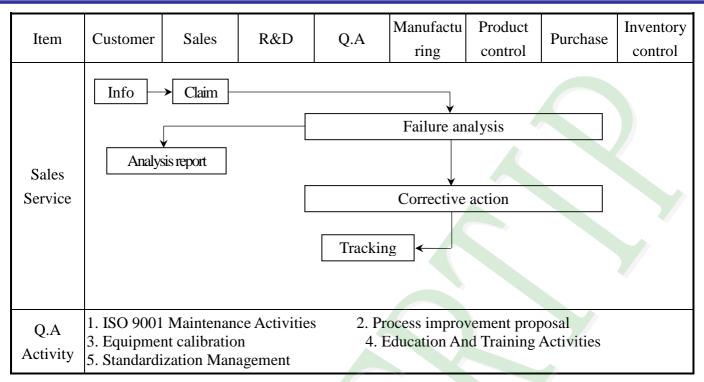


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3. 5" ~10" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample

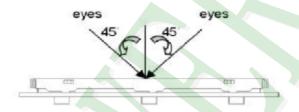
◆Defect Level: Major Defect AQL: 0.4 ; Minor Defect AQL: 1.5

♦OUT Going Defect Level: Sampling.

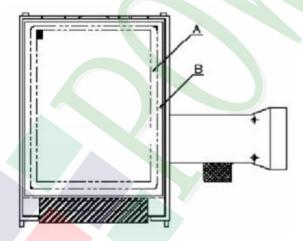
Standard of the product appearance test :

a. Manner of appearance test:

- (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3, 5" ~10": (Ver.B01)

NO	Item	Criterion	Level		
		1. 1The part number is inconsistent with work order of production.	Major		
01	Product condition	1. 2 Mixed product types.	Major		
		1. 3 Assembled in inverse direction.	Major		
02	Quantity	2. 1The quantity is inconsistent with work order of production.			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.			
		4. 1 Missing line character and icon.	Major		
		4. 2 No function or no display.	Major		
04	Electrical Testing	4. 3 Display malfunction.	Major		
		4. 4 LCD viewing angle defect.	Major		
		4, 5 Current consumption exceeds product specifications.	Major		
		Item Acceptance (Q'ty)			
	Dot defect	Bright Dot ≤ 4			
		Dot Dark Dot ≤ 5			
	(Bright dot \	Defect Joint Dot ≤ 3			
05	Dark dot)	Total ≤ 7	Minor		
	On -display 5, 1 Inspe	5. 1 Inspection pattern : full white , full black , Red , Green and	L		
		blue screens.			
		5. 2 It is defined as dot defect if defect area $>1/2$ dot.			
		5, 3 The distance between two dot defect ≥5 mm.	<u>.</u>		



♦ Speci	fication For TFT-LCD	Module 3. 5" ~10" :			(Ver.B01)
NO	Item	Cr	iterion		Level
06	Black or white dot × scratch × contamination Round type X	$L \le 10.0$ $0.03 < W$ $L \le 5.0$ $0.05 < W$	Acceptance A area Ignore 5 0 5 display): Accep A area Acceptance A area Ignore 4	Ignore Ignore B area B area Tenore Ignore	Minor
07	Polarizer Bubble	Dimension (diameter : Φ) $Φ \le 0.25$ $0.25 < Φ \le 0.50$ $0.50 < Φ \le 0.80$ $Φ > 0.80$ Total	Acceptance A area Ignore 4 1 0 5	e (Q'ty) B area Ignore	Minor



◆Specification For TFT-LCD Module 3. 5" ~10":

(Ver.B01)

NO	Item	Criterion	Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length	
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and crack between panels:	
		V X V	
08	The crack of glass	SP SP [NG]	Minor
		Seal width	
		X Y Z	
		≤ a Crack can't enter viewing area ≤1/2 t	
•		\leq a Crack can't exceed the half of SP width. 1/2 t < Z \leq 2 t	



◆Specification For TFT-LCD Module 3. 5" ~10": (Ver.B01) NO Item Criterion Level Symbols: Y: The width of crack. X: The length of crack Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 8.1.2 Corner crack: X Y Z Crack can't enter ≤1/5 a $Z \leq 1/2 t$ viewing area Crack can't exceed the $1/2 t < Z \leq 2 t$ ≤1/5 a half of SP width. 08 The crack of glass Minor 8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad: X Y Z ≤ 1/2 W Front $\leq t$ $\leq a$ Back $\leq a$ ≤ W $\leq 1/2 t$



◆Specification For TFT-LCD Module 3. 5" ~10":

(Ver.B01)

NO	Item	Criterion		
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length S. 2. 2 Non-conductive portion:	-	
		ZAL		
08	The crack of	$\begin{array}{c cccc} X & Y & Z \\ & \leq 1/3 & a & \leq W & \leq t \end{array}$	Mino	
	glass	⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode		
		terminal specifications.		
		8. 2, 3 Glass remain :		
		$\begin{array}{c cccc} X & Y & Z \\ & \leq a & \leq 1/3 \text{ W} & \leq t \end{array}$		



	ication For TET L	CD Module 3. 5″ ~10″:	(V P01)
[•	(Ver.B01)
NO	Item	Criterion	Level
		9. 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
		10. 1 Pin type \quantity \quantity \dimension must match type in structure diagram.	Major
		10, 2 No short circuits in components on PCB or FPC .	Major
	General	10.3 Parts on PCB or FPC must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	Major
10	appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤ 1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

1 2 3	High Temperature Storage Test Low Temperature Storage Test High Temperature / High Humidity Storage Test Temperature Cycling Storage Test	Surrounding Keep in -30 Surrounding Keep in +60 Surrounding (Excluding to	±2°C 96 hrs g temperature, then sto c / 90% R.H duration g temperature, then sto the polarizer) -30°C \rightarrow +25°C \rightarrow (30mins) (5mins) (10 Cyc	orage at normal condition for 96 hrs orage at normal condition for 96 hrs orage at normal condition $+80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ (30mins) (5mins)	on 4hrs.	
3	Storage Test Low Temperature Storage Test High Temperature / High Humidity Storage Test Temperature Cycling	Surrounding Keep in -30 Surrounding Keep in +60 Surrounding (Excluding to	g temperature, then stored $\pm 2^{\circ}\mathbb{C}$ 96 hrs g temperature, then stored $\pm 2^{\circ}\mathbb{C}$ / 90% R.H duration g temperature, then stored the polarizer) $-30^{\circ}\mathbb{C} \rightarrow +25^{\circ}\mathbb{C} \rightarrow (30 \text{mins}) (5 \text{mins}) (4 \text{mins})$	orage at normal condition for 96 hrs orage at normal condition $+80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins)	on 4hrs.	
3	Storage Test High Temperature / High Humidity Storage Test Temperature Cycling	Surrounding Keep in +60 Surrounding (Excluding to	g temperature, then stored the polarizer) -30 $^{\circ}$ C \rightarrow +25 $^{\circ}$ C \rightarrow (30mins) (5mins) (n for 96 hrs orage at normal condition $+80^{\circ} \rightarrow +25^{\circ} \subset (30 \text{mins})$		
	High Humidity Storage Test Temperature Cycling	Surrounding (Excluding t	g temperature, then sto the polarizer) $-30^{\circ} \rightarrow +25^{\circ} \rightarrow +25^{\circ} \rightarrow (30 \text{mins}) (5 \text{mins}) (4 \text{mins}) $	orage at normal condition $+80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ (30mins) (5mins)	on 4 hrs.	
4		Surrounding	(30mins) (5mins) (10 Cyc	(30 mins) (5 mins)		
			$-30^{\circ}\mathbb{C} \rightarrow +25^{\circ}\mathbb{C} \rightarrow +80^{\circ}\mathbb{C} \rightarrow +25^{\circ}\mathbb{C}$ $(30 \text{mins}) (5 \text{mins}) (5 \text{mins})$ $\boxed{10 \text{ Cycle}}$ Surrounding temperature, then storage at normal condition 4hrs.			
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: $15^{\circ} \sim 35^{\circ}$ 2. Humidity relative: $30\% \sim 60\%$ 3. Energy Storage Capacitance(Cs+Cd): 150 pF±10% 4. Discharge Resistance(Rd): $330 \Omega \pm 10\%$ 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: $\pm 5\%$)				
6	Vibration Test (Packaged)	3. Each die		vave 10~55 Hz frequen mplitude of vibration : 1 vation for 2 Hrs	• ,	
7	Drop Test (Packaged)		Packing Weight (Kg) 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454	Drop Height (cm)		



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

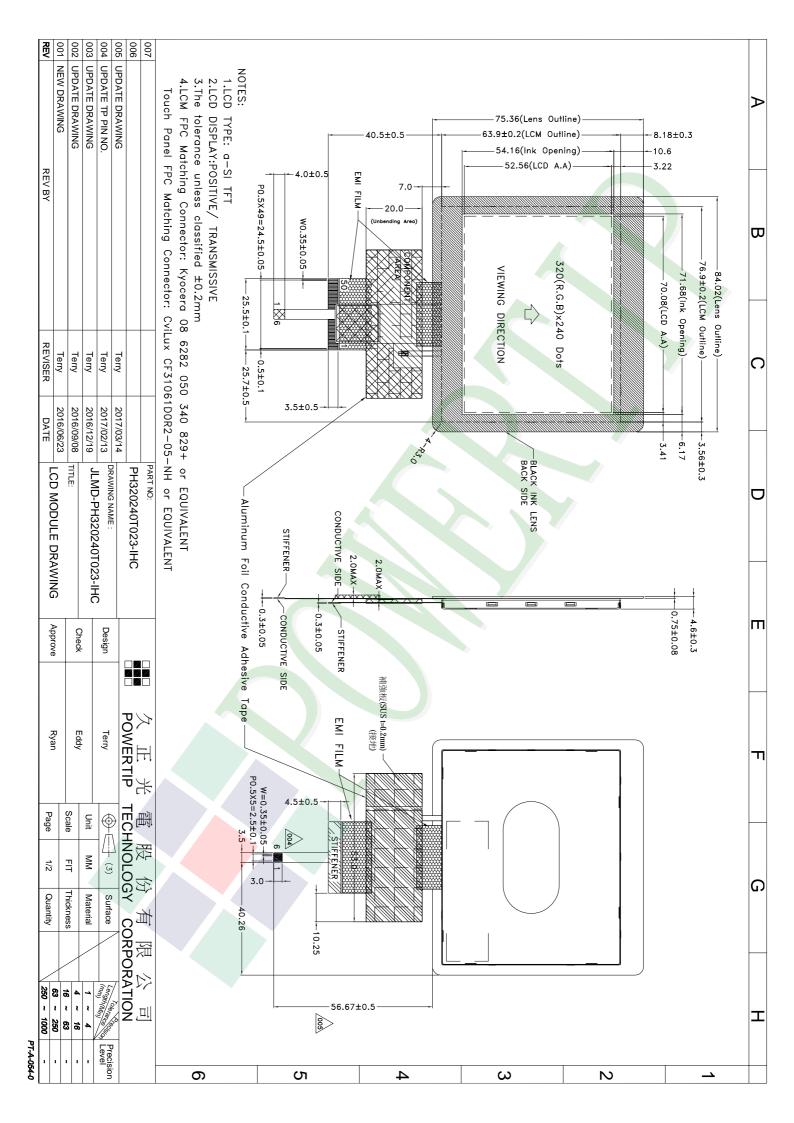
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Documents NO. | JPKG-PH320240T023-IHC Ryan Eddy Terry (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. 1Pcs Weight Total Weight Item Model Dimensions (mm) **Ouantity** PH320240T023-IHC 84.02X75.3X4.6 1 成品 (LCM) 252 0.0448 11.2896 2 多層薄膜(1)POF OTFILM0BA03ABA 19"X350X0.015 6 3 TY00000000408 352 X 260 X 12.3 48 TRAY 盤 (2)Tray 0.1 4.8 4 内盒(3)Product Box BX36627063ABBA 393 X 274 X 68 0.182 1.092 6 5 OTPLB00PL08ABA 2 保利龍板(4)Polylon board 550 X 393 X 20 0.0284 0.0568 1 6 外紙箱(5)Carton BX57041027CCBA 570 X 410 X 265 1.0 1.0 7 8 9 2.一 整箱總重量 (Total LCD Weight in carton): 18.24 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray 6 x no of tray 7 42 (2)Total LCM quantity in carton: quantity per box x no of boxes 42 6 252 Use empty tray 空盤 (4)保利龍板 (1)多層薄膜 Polylon board POF Put products into the tray (2)TRAY 盤 Tray (5)外紙箱 Carton Tray stacking (3)内盒 Product Box 特 記 事 項 (REMARK) 1. Label Specifications: Detail B 依廠內標準作業 Tray 2 圓角 Tray 1 2.TRAY盤相疊時,需旋轉180度,請詳見B視圖

Rotate tray 180 degrees and place on top of stack.

Check the tray stack using Fig. B.